Doc code: IDS Doc description: Information Disclosure Statement (IDS) Filed

PTO/SB/08a (01-10)

Approved for use through 07/31/2012. OMB 0651-0031

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	Application Number		10565715	
	Filing Date		2006-06-12	
INFORMATION DISCLOSURE	First Named Inventor	Luis A	Alfredo Diaz Chavez	
STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Art Unit		1734	
	Examiner Name	Rebed	cca Y. Lee	
	Attorney Docket Number		22080.002	

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